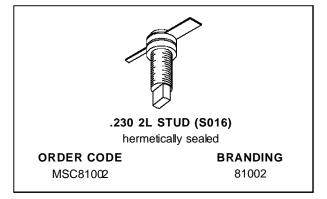
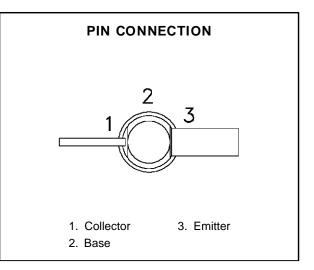


# **MSC81002**

# RF & MICROWAVE TRANSISTORS GENERAL PURPOSE AMPLIFIER APPLICATIONS

- EMITTER BALLASTED
- VSWR CAPABILITY ∞:1 @ RATED CONDITIONS
- HERMETIC STRIPAC<sup>®</sup> PACKAGE
- $P_{OUT} = 2.0$  W MIN. WITH 10 dB GAIN @ 1 GHz





# DESCRIPTION

The MSC81002 is a common base hermetically sealed silicon NPN microwave transistor utilizing a fishbone, emitter ballasted geometry with a re-fractory/gold metallization system. This device is capable of withstanding an infinite load VSWR at any phase angle under rated conditions.

The MSC81002 was designed for Class C amplifier applications in the 0.4 - 1.2 GHz frequency range.

#### **ABSOLUTE MAXIMUM RATINGS** ( $T_{case} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit	
PDISS	Power Dissipation* $(T_C \le 75^{\circ}C)$	6.25	W	
Ι <sub>C</sub>	Device Current*	200		
V <sub>CC</sub>	Collector-Supply Voltage*	35	V	
TJ	Junction Temperature	200	°C	
T <sub>STG</sub>	Storage Temperature	– 65 to +200	°C	

#### THERMAL DATA

RTH(j-c)	Junction-Case Thermal Resistance*	20	°C/W		
*Applies only to rated RF amplifier operation					

# MSC81002

# **ELECTRICAL SPECIFICATIONS** $(T_{case} = 25^{\circ}C)$

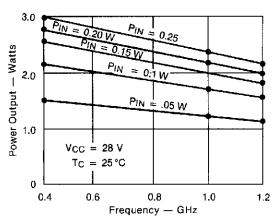
STATIC

Symbol	Test Conditions	Value			Unit	
	Test conditions		Min.	Тур.	Max.	
BV <sub>CBO</sub>	$I_C = 1 m A$	$I_E = 0 m A$	45	—	_	V
BV <sub>EBO</sub>	$I_E = 1 m A$	$I_C = 0 m A$	3.5	—	—	V
BVCER	IC = 5mA	$R_{BE} = 10\Omega$	45		—	V
I <sub>СВО</sub>	$V_{CB} = 28V$		—	_	0.5	mA
h <sub>FE</sub>	$V_{CE} = 5V$	I <sub>C</sub> = 100mA	15		120	—

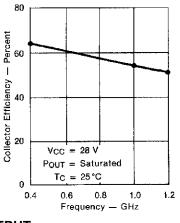
#### DYNAMIC

Symbol	Test Conditions		Value			llm:4	
Symbol	Test Conditions			Min.	Тур.	Max.	Unit
Pout	f = 1.0 GHz	$P_{IN}=0.2\ W$	$V_{CC}=28\ V$	2.0	2.2		W
ηc	f = 1.0 GHz	$P_{IN}=0.2\ W$	$V_{CC} = 28 V$	50	55	—	%
GP	f = 1.0 GHz	$P_{IN}=0.2\ W$	$V_{CC} = 28 V$	10	10.4	—	dB
Сов	f = 1 MHz	$V_{CB} = 28 V$		—		3.2	pF

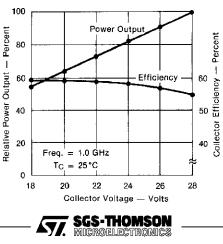
## TYPICAL PERFORMANCE POWER OUTPUT vs FREQUENCY



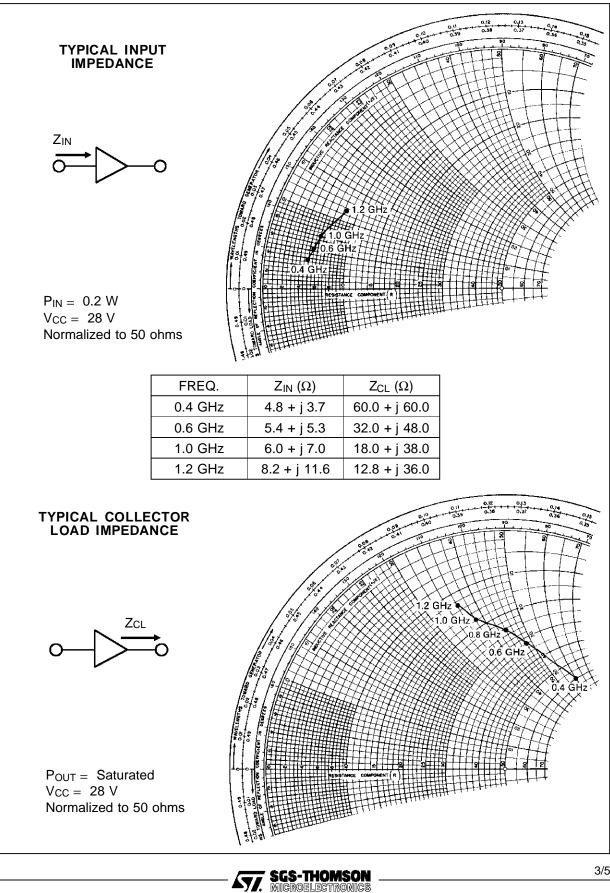
#### COLLECTOR EFFICIENCY vs FREQUENCY



#### RELATIVE POWER OUTPUT vs COLLECTOR VOLTAGE

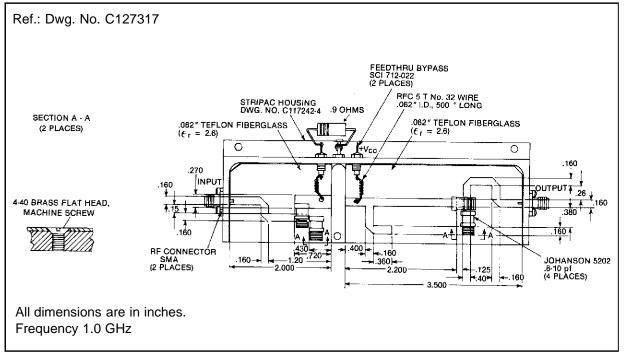


### **IMPEDANCE DATA**

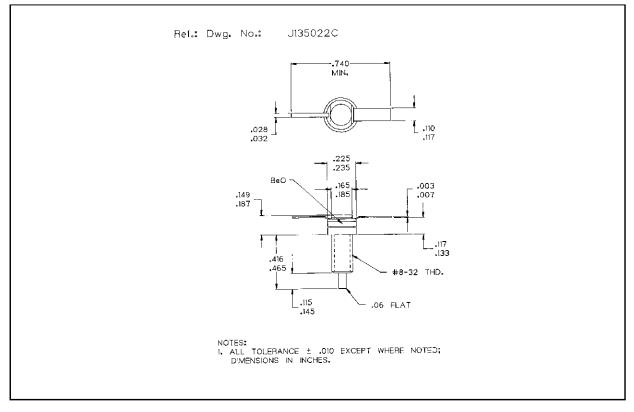


# MSC81002

### **TEST CIRCUIT**



# PACKAGE MECHANICAL DATA





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